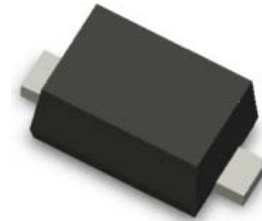


# RB520S30

## Schottky Barrier Diodes

- Low Forward Voltage Drop
- Flat Lead, Surface Mount Device at 0.60mm Height
- Extremely Small Outline Plastic Package SOD523F
- Moisture Level Sensitivity 1
- Pb-free Version and RoHS Compliant
- Matte Tin (Sn) Lead Finish
- Green Mold Compound



SOD-523F  
Band Indicates Cathode\*  
Marking: 1B(520S)

### Absolute Maximum Ratings\* $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	30	V
$I_{F(AV)}$	Average Rectified Forward Current	200	mA
$T_J$	Operating Junction Temperature Range	-55 to +125	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to +125	$^\circ\text{C}$

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### Thermal Characteristics

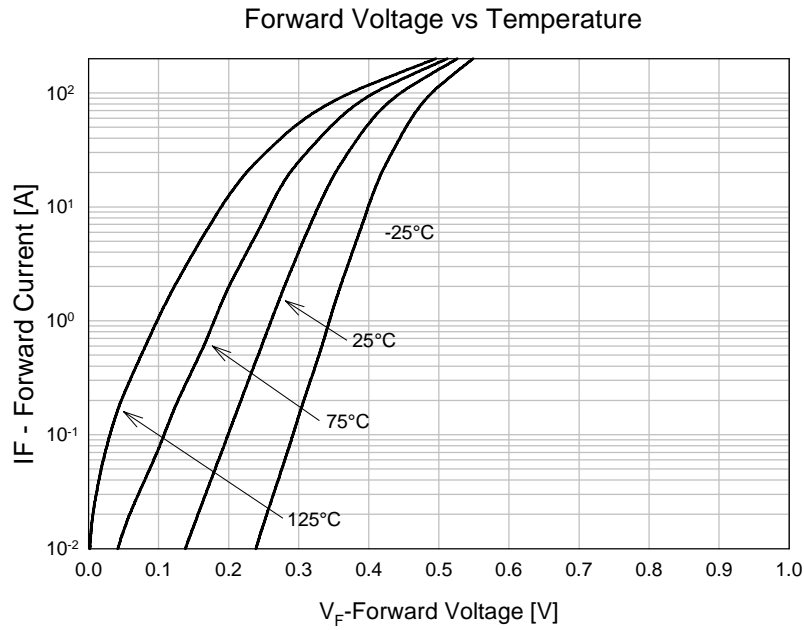
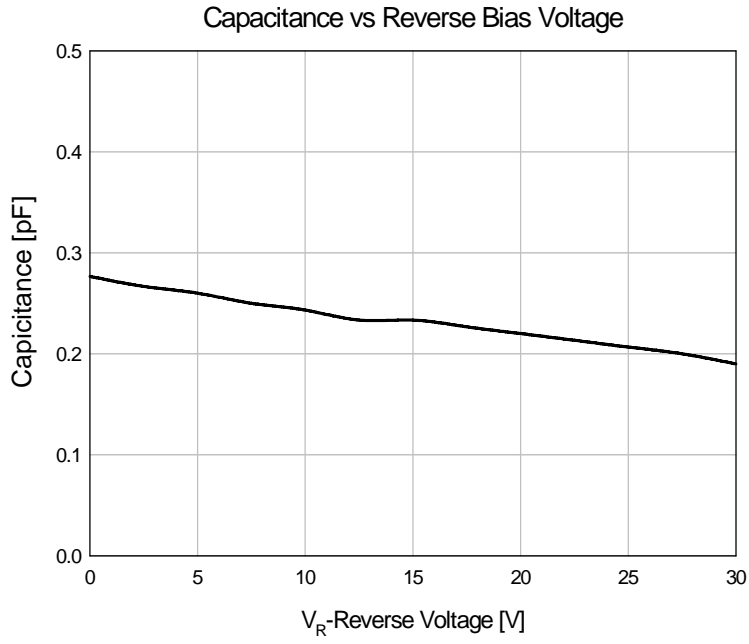
Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	$^\circ\text{C}/\text{W}$
$P_D$	Total Device Dissipation( $T_C=25^\circ\text{C}$ )	200	mW

\*Device mounted on FR-4 PCB minimum land pad.

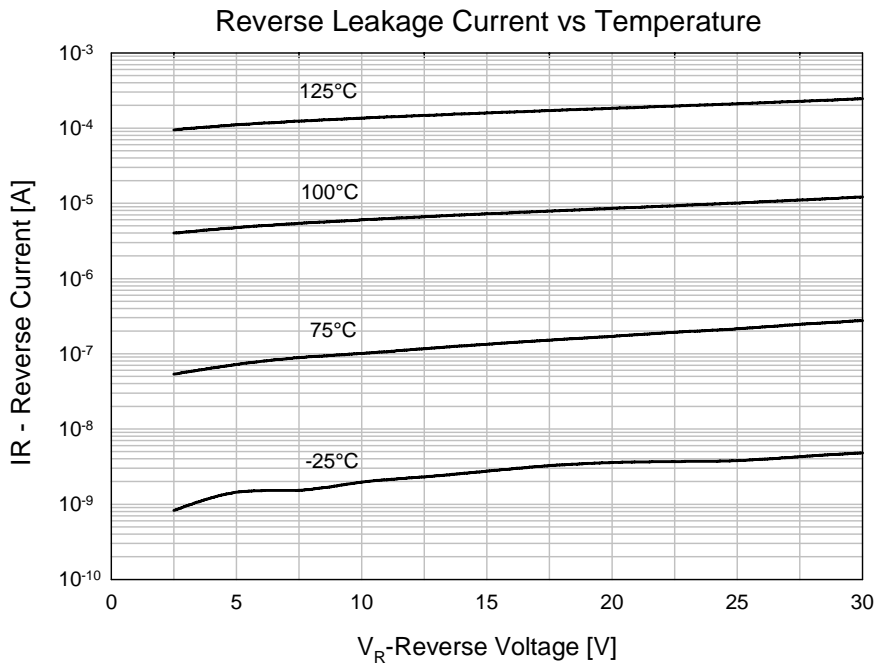
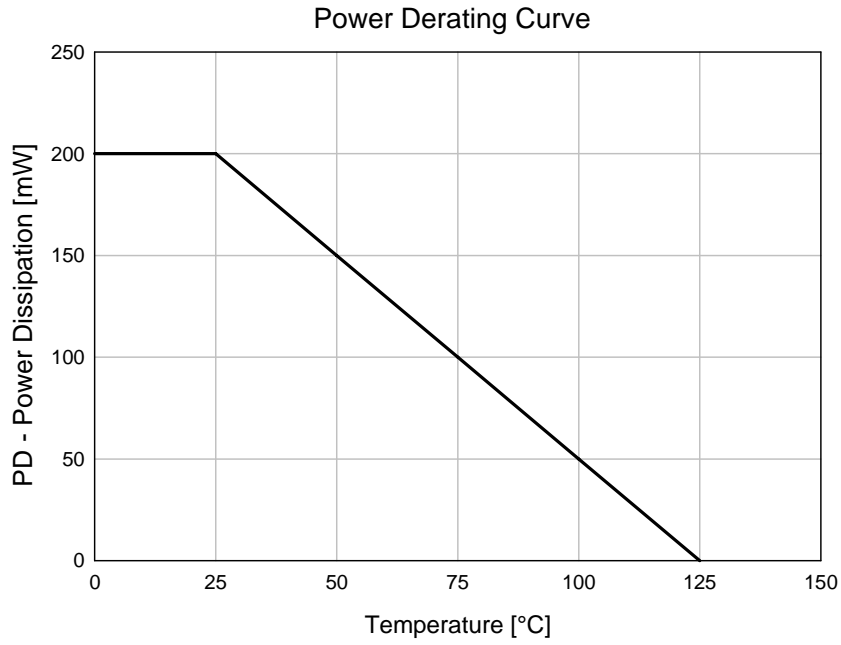
### Electrical Characteristics\* $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$BV_R$	Breakdown Voltage	$I_R = 500 \mu\text{A}$	30			V
$I_R$	Reverse Current	$V_R = 10 \text{ V}$			1	$\mu\text{A}$
$V_F$	Forward Voltage	$I_F = 100 \text{ mA}$			0.6	V

Typical Performance Characteristics

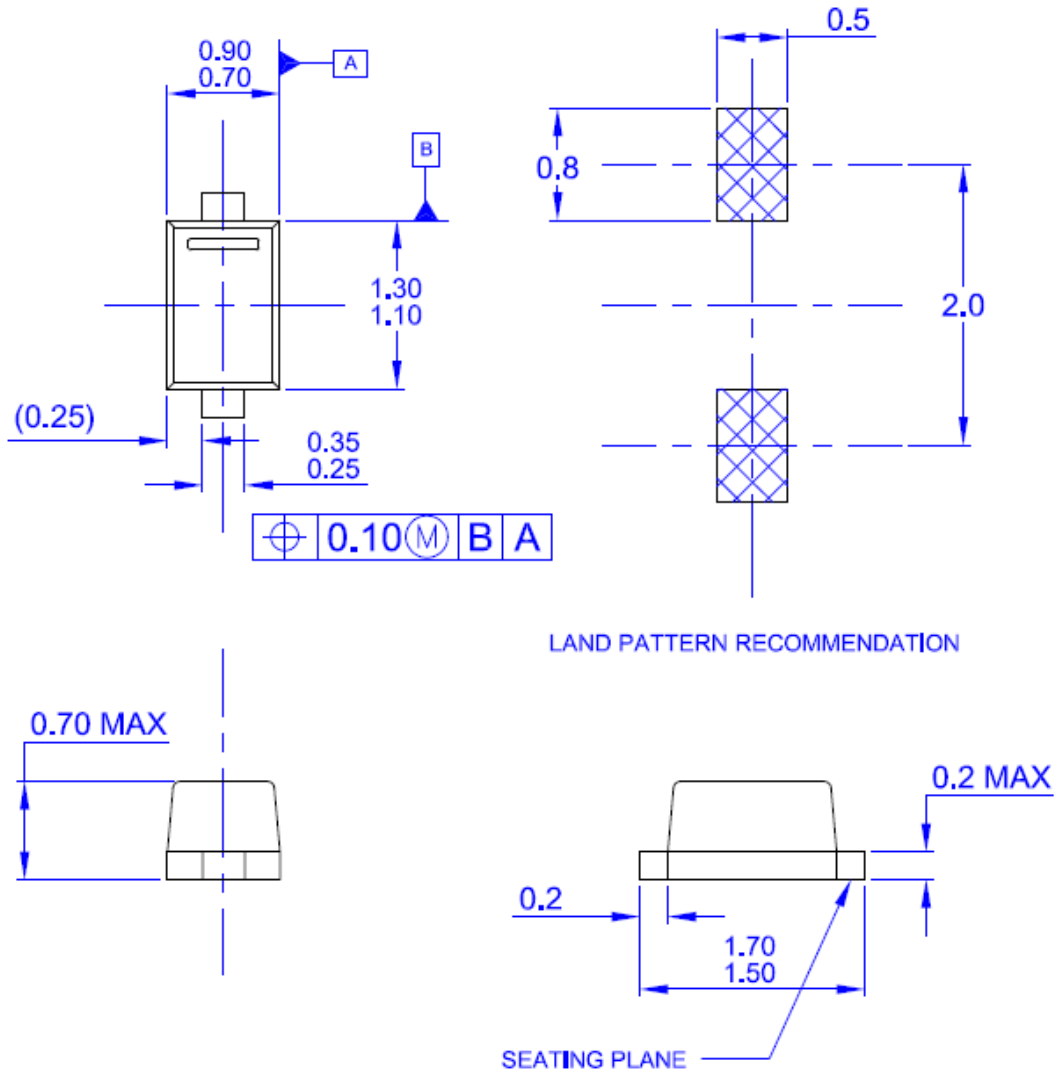


Typical Performance Characteristics



Package Dimension

SOD-523F




NOTES; UNLESS OTHERWISE SPECIFIED

- A) PACKAGE REFERENCE; THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M - 1994
- D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M.
- F) DRAWING NUMBER AND REVISION;MKT-SOD523F1rev1



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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

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